

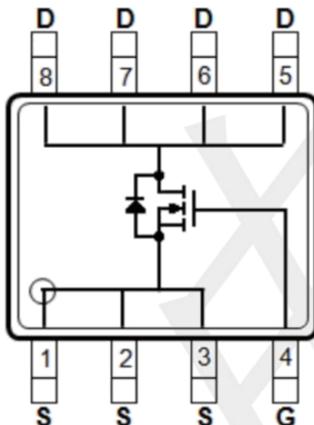
## Product Summary

- $V_{DS}$  100 V
- $I_{DS}$  (@  $V_{GS} = 10V$ ) 3A
- $R_{DS(ON)}$  (@  $V_{GS} = 10V$ )  $\leq 88m\Omega$ (Typ)

## Application

- LED Backlighting
- Synchronous Rectifiers for SMPS
- Power management
- PWM Application

## Package and Pin Configuration& Circuit diagram(SOP8)



## Absolute Maximum Ratings (T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	$V_{DS}$	100	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current T <sub>A</sub> =25°C	$I_D$	3.0	A
Continuous Drain Current T <sub>A</sub> =85°C	$I_D$	2.2	A
Pulsed Drain Current (note1)	$I_{DM}$	12	A
Maximum Power Dissipation, T <sub>A</sub> =25°C	$P_D$	3.5	W
Operating Junction Temperature Range	$T_J$	-55 to +150	°C
Storage Temperature Range	$T_{stg}$	-55 to +150	°C

## Thermal Characteristic

PARAMETER	Symbol	Value	Unit
Thermal Resistance Junction-ambient	$R_{\theta JA}$ (note2)	70	°C/W
Thermal Resistance Junction-Case		36	°C/W

notes 1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2 . When mounted on 1" square PCB (FR4 material).

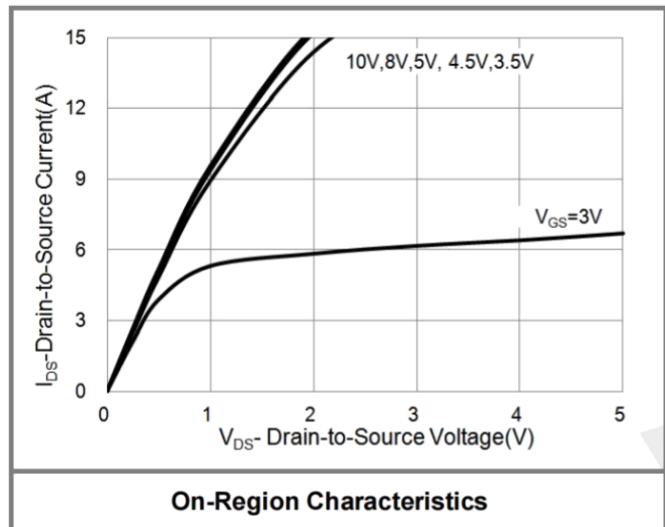
**Electrical Characteristics** ( $T_A=25^\circ\text{C}$  unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu\text{A}$	$BV_{DSS}$	100	--	--	V
Gate-Source Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	$V_{GS(\text{th})}$	1.0	1.5	2.5	V
Gate-Source Leakage	$V_{DS}=0V, V_{GS}=\pm 20V$	$I_{GSS}$	--	--	$\pm 100$	nA
Zero Gate Voltage Drain Current	$V_{DS}=100V, V_{GS}=0V$	$I_{DSS}$	--	--	1	$\mu\text{A}$
	$V_{DS}=100V, T_J=85^\circ\text{C}$		--	--	30	$\mu\text{A}$
Drain-Source On-State Resistance (Note 1)	$V_{GS}=10V, I_D=3A$	$R_{DS(\text{on})}$	--	88	119	$\text{m}\Omega$
	$V_{GS}=4.5V, I_D=2A$		--	100	148	
Forward Transconductance (Note 2)	$V_{DS}=5V, I_D=2A$	$g_{fs}$	--	28	--	S
<b>Dynamic</b> (Note 2)						
Total Gate Charge (Note 3)	$V_{DS}=50V, I_D=2A, V_{GS}=10V$	$Q_g$	--	12	--	nC
Gate-Source Charge (Note 3)		$Q_{gs}$	--	2.2	--	
Gate-Drain Charge (Note 3)		$Q_{gd}$	--	2.5	--	
Input Capacitance	$V_{DS}=25V, V_{GS}=0V, F=1.0\text{MHz}$	$C_{iss}$	--	610	--	pF
Output Capacitance		$C_{oss}$	--	40	--	
Reverse Transfer Capacitance		$C_{rss}$	--	25	--	
<b>Switching</b>						
Turn-On Delay Time (Note 3)	$V_{DD}=50V, I_D=3A, V_{GS}=10V, R_G=1.8\Omega$	$t_{d(on)}$	--	7	--	nS
Rise Time (Note 3)		$t_r$	--	5	--	
Turn-Off Delay Time (Note 3)		$t_{d(off)}$	--	16	--	
Fall Time (Note 3)		$t_f$	--	6	--	
<b>Source-Drain Diode Ratings and Characteristics</b> (Note 2)						
Forward Voltage	$V_{GS}=0V, I_{SD}=3A$	$V_{SD}$	--	0.8	1.2	V
Continuous Source Current	Integral reverse diode in the MOSFET	$I_S$	--	--	3	A
Pulsed Current (Note 1)		$I_{SM}$	--	--	12	A

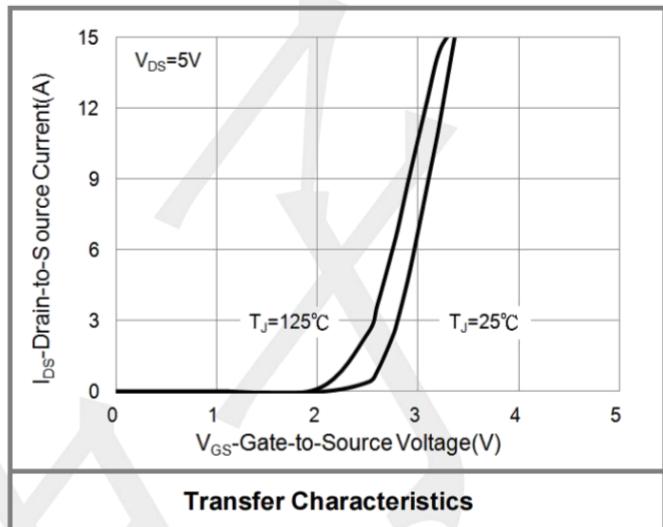
Notes:

1. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .
2. Guaranteed by design, not subject to production testing.
3. Independent of operating temperature

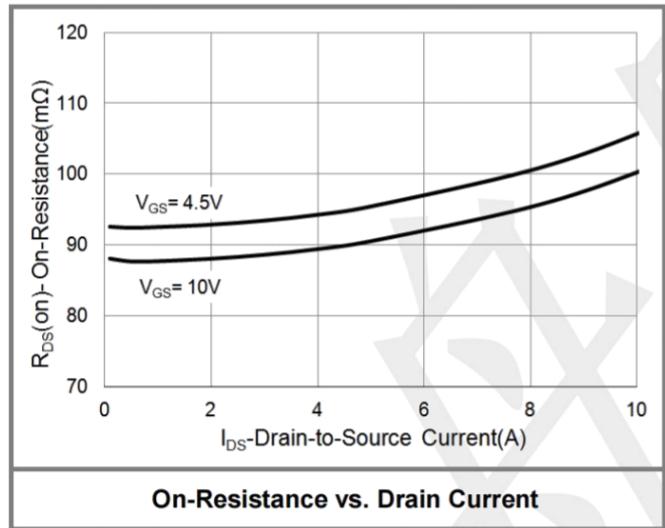
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



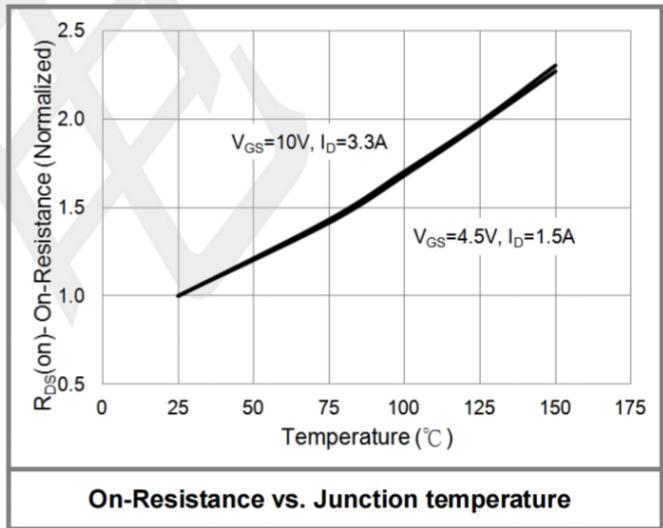
On-Region Characteristics



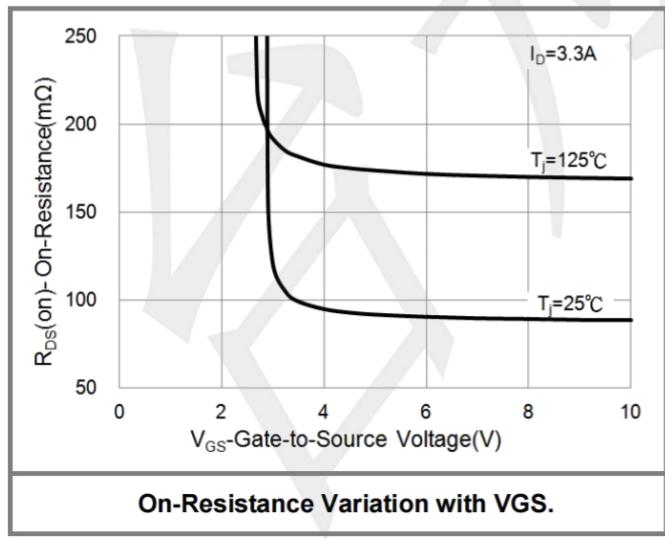
Transfer Characteristics



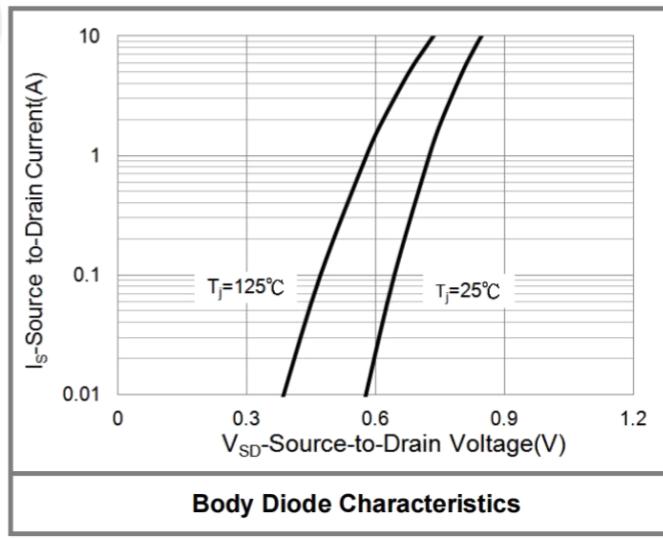
On-Resistance vs. Drain Current



On-Resistance vs. Junction temperature



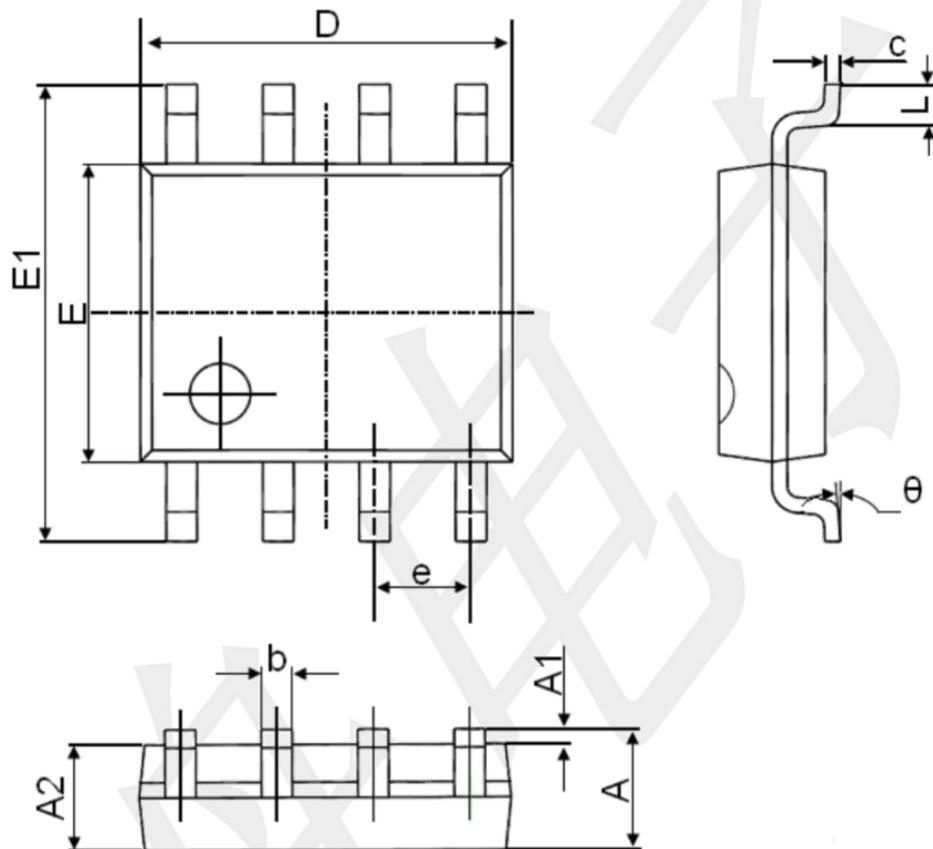
On-Resistance Variation with VGS.



Body Diode Characteristics

## Package Information

SOP8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°